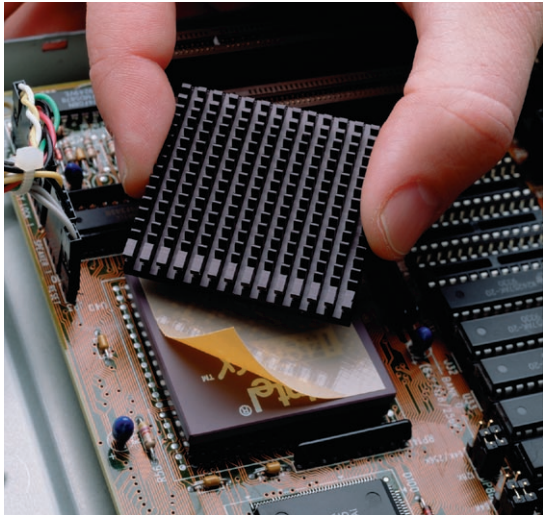


## Thermally Conductive Material for Cooling Central Processing Units



Bergquist CPU Pad is a thermally conductive, electrically insulating, double coated tape. The tape consists of a high performance acrylic, pressure sensitive adhesive, on both sides of a film. This product can be used in applications that currently require clips. CPU Pad is typically used to mount a heat sink on top of a central processing unit on the circuit board.

### Application Force for CPU Pad

CPU Pad is a high performance, acrylic, pressure sensitive adhesive. Being pressure sensitive, the adhesive makes a strong bond to surfaces with little or no pressure. Parts can simply be assembled and placed on the CPU Pad. Immediately after placement, the parts are securely bonded together. No long clamping times or high pressures are required.

### Mounting Procedure

1. Insure cleanliness of central processing unit and heat sink.
2. Remove the clear liner from one side of the CPU Pad.
3. Roll the pad onto the substrate.
4. Remove the white liner.
5. With moderate pressure (less than 10 psi), press the part in place.

### TYPICAL PROPERTIES OF CPU Pad

| PROPERTY   | TYPICAL VALUE            | METRIC VALUE/ 5 MIL      | TYPICAL VALUE 9 MIL       | TEST METHOD   |
|--|--------------------------|--------------------------|---------------------------|---------------|
| Color  | Tan                      | Tan                      | Tan                       | Visual        |
| Thickness  | .005 ±.001               | .127 mm                  | .009 ± .001               | ASTM D 374    |
| Tensile Strength   | 5000 psi                 | 35 MPa                   |                           | ASTM D 412    |
| Elongation   | 40 %                     | 40 %                     |                           | ASTM D 412    |
| Glass Transition   | -70 °C                   | -70 °C                   | -70 °C                    | TMA           |
| <b>Adhesion</b>  |                          |                          |                           |               |
| Adhesion to Aluminum                                       | 4 lbs./in                | 7 N/cm                   | 2700 grams per in.        | ASTM D 1876   |
| Adhesion to Liner  | 16 g/inch                | 6 N/m                    | 50 gr. grams per in.      | ASTM D 1876   |
| Tensile Shear  | 120 psi                  | .84 MPa                  | 140 psi                   | ASTM D 1002   |
| <b>Thermal Properties</b>                                  |                          |                          |                           |               |
| Thermal Conductivity                                       | 0.6 W/m-K                | 0.6 W/m-K                | 0.4 W/m-K                 | ASTM D5470    |
| Thermal Resistance   | 0.3 C-in <sup>2</sup> /W | 1.9 °Cmm <sup>2</sup> /w | .42 °C-in <sup>2</sup> /W | ASTM D5470    |
| Thermal Coefficient of expansion                           | 450 ppm                  | 450 ppm                  |                           | TMA           |
| <b>Thermal Cycling</b> 1 Hour at -50°C and 1 Hour at 150°C |                          |                          |                           |               |
| <b>Time</b>  | <b>Peel Adhesion</b>     | <b>Voltage Breakdown</b> |                           | <b>Visual</b> |
| Cycles   | PLI (N/cm)               |                          |                           |               |
| 0  | 3.6 (6.4)                | 6000                     |                           | Pass          |
| 100  | 3.8 (6.8)                | 6000                     |                           | Pass          |
| 200  | 4.5 (8.1)                | 6000                     |                           | Pass          |
| 300  | 4.7 (8.4)                | 6000                     |                           | Pass          |